

TN05P30JPA

P-Channel Enhancement Mode Power MOSFET

Product Summary

- $V_{DS} = -30V, I_D = -5.1A$
- $R_{DS(on)} < 43m\Omega @ V_{GS} = -10V$
- $R_{DS(on)} < 65m\Omega @ V_{GS} = -4.5V$

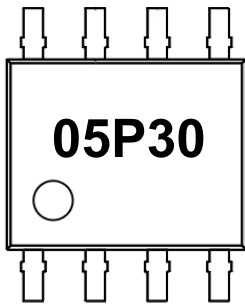
Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

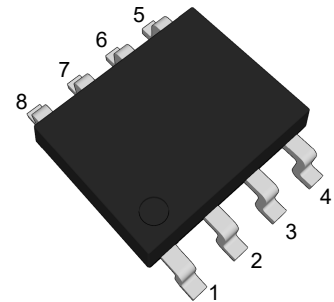
Application

- Power Switching Application
- Uninterruptible Power Supply

Marking Code



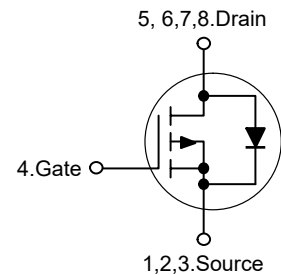
SOP-8



(Top View)

Pin	Description
1,2,3	Source
4	Gate
5,6,7,8	Drain

Schematic Diagram



Absolute Maximum Ratings

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$-V_{DS}$	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	$-I_D$	5.1	A
Drain Current-Pulsed ^{Note1}	$-I_{DM}$	20	A
Maximum Power Dissipation	P_D	1.4	W
Single Pulse Avalanche Energy ^{Note2}	E_{AS}	12	mJ
Junction Temperature	T_J	150	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C

Thermal Characteristics

Thermal Resistance, Junction-to-Ambient ^{Note3}	$R_{\theta JA}$	89	°C/W
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Electrical Characteristics

(Ta=25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V	-30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V	-	-	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =-250μA	-1.0	-1.8	-2.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance ⁽³⁾	V _{GS} =-10V, I _D =-5A	-	31	43	mΩ
		V _{GS} =-4.5V, I _D =-4A	-	46	65	
V _{SD}	Diode Forward Voltage	I _S =-5.1A, V _{GS} =0V	-	-	-1.2	V
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz	-	537	-	pF
C _{oss}	Output Capacitance		-	73	-	pF
C _{rss}	Reverse Transfer Capacitance		-	55	-	pF
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =-10V, V _{DD} =-15V, I _D =-2A	-	10.9	-	nC
Q _{gs}	Gate Source Charge		-	2.1	-	nC
Q _{gd}	Gate Drain Charge		-	2.1	-	nC
t _{D(on)}	Turn-On Delay Time	V _{GS} =-10V, V _{DD} =-15V, I _D =-2A, R _{GEN} =3Ω	-	2.9	-	ns
t _r	Turn-On Rise Time		-	2.1	-	ns
t _{D(off)}	Turn-Off Delay Time		-	25	-	ns
t _f	Turn-Off Fall Time		-	13	-	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-2A, di/dt=100A/μs	-	8.7	-	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-2A, di/dt=100A/μs	-	2.9	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
2. EAS condition: Starting T_J=25°C, V_{DD}=-15V, V_G=-10V, R_G=25ohm, L=0.5mH, I_{AS}=-7A
3. Pulse Test: Pulse Width≤300us, Duty Cycle≤0.5%
4. R_{θJA} is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.

Typical Characteristic Curves

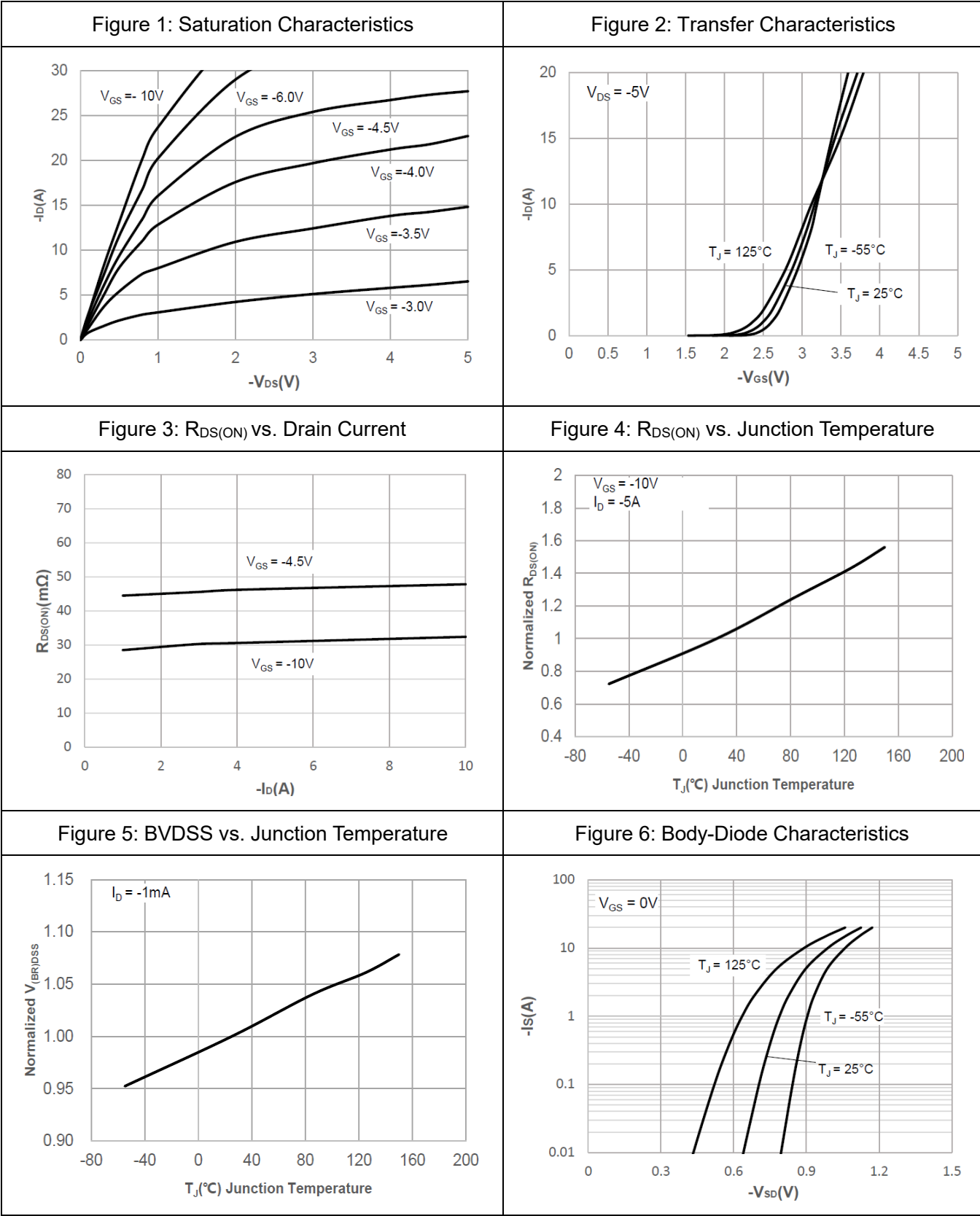


Figure 7: Gate-Charge characteristics

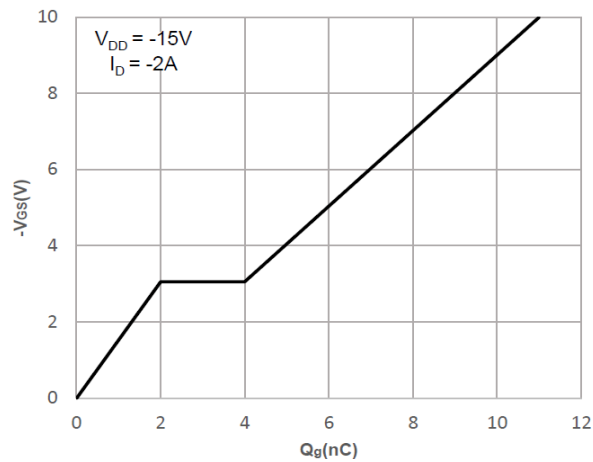


Figure 8: Capacitance characteristics

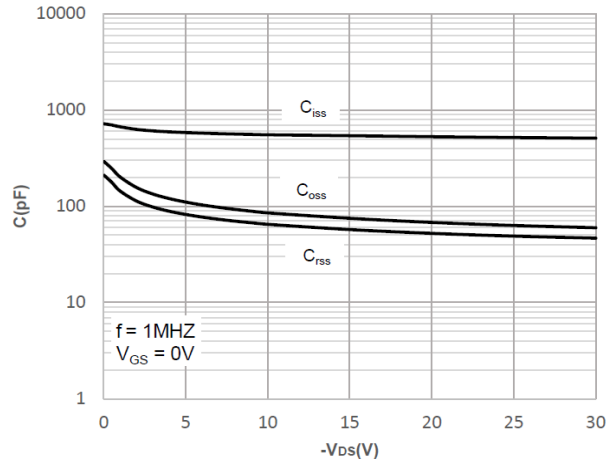


Figure 9: Current De-rating

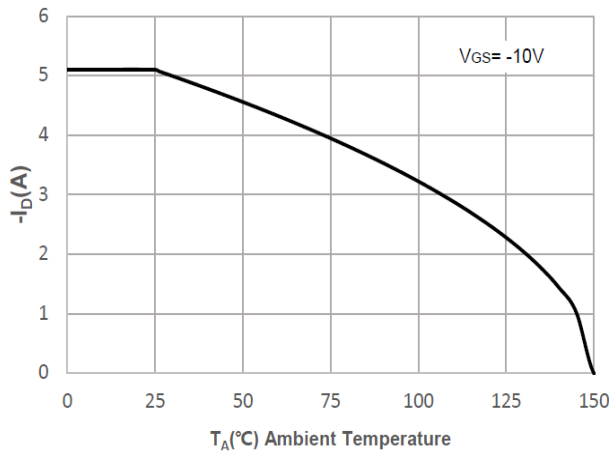


Figure 10: Maximum Safe Operating Area

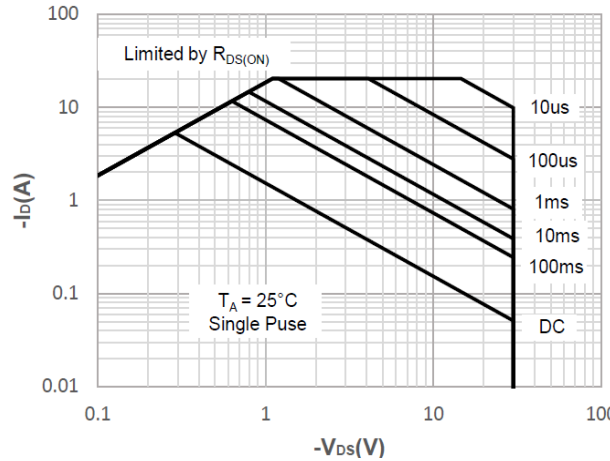


Figure 11: Normalized Maximum Transient Thermal Impedance

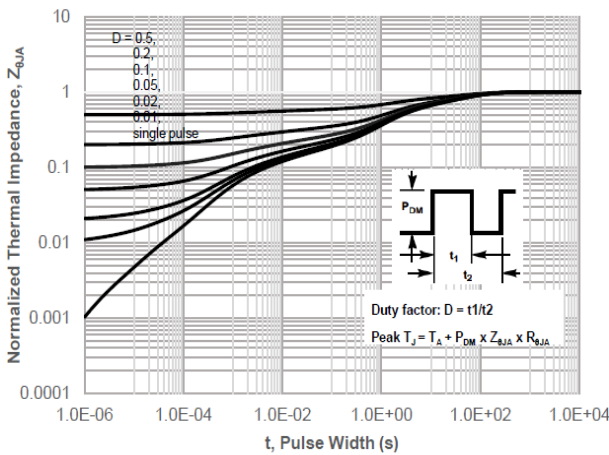
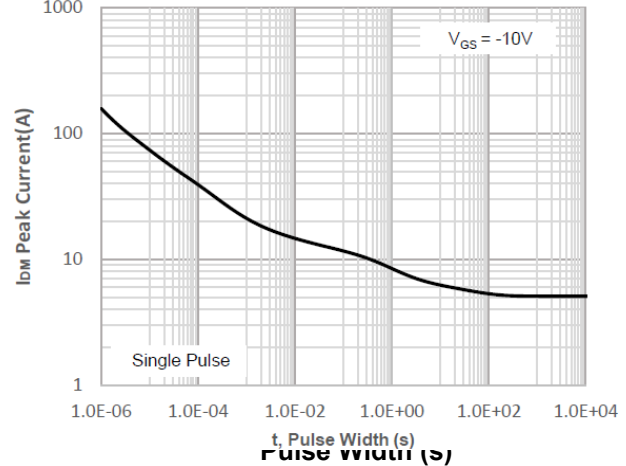
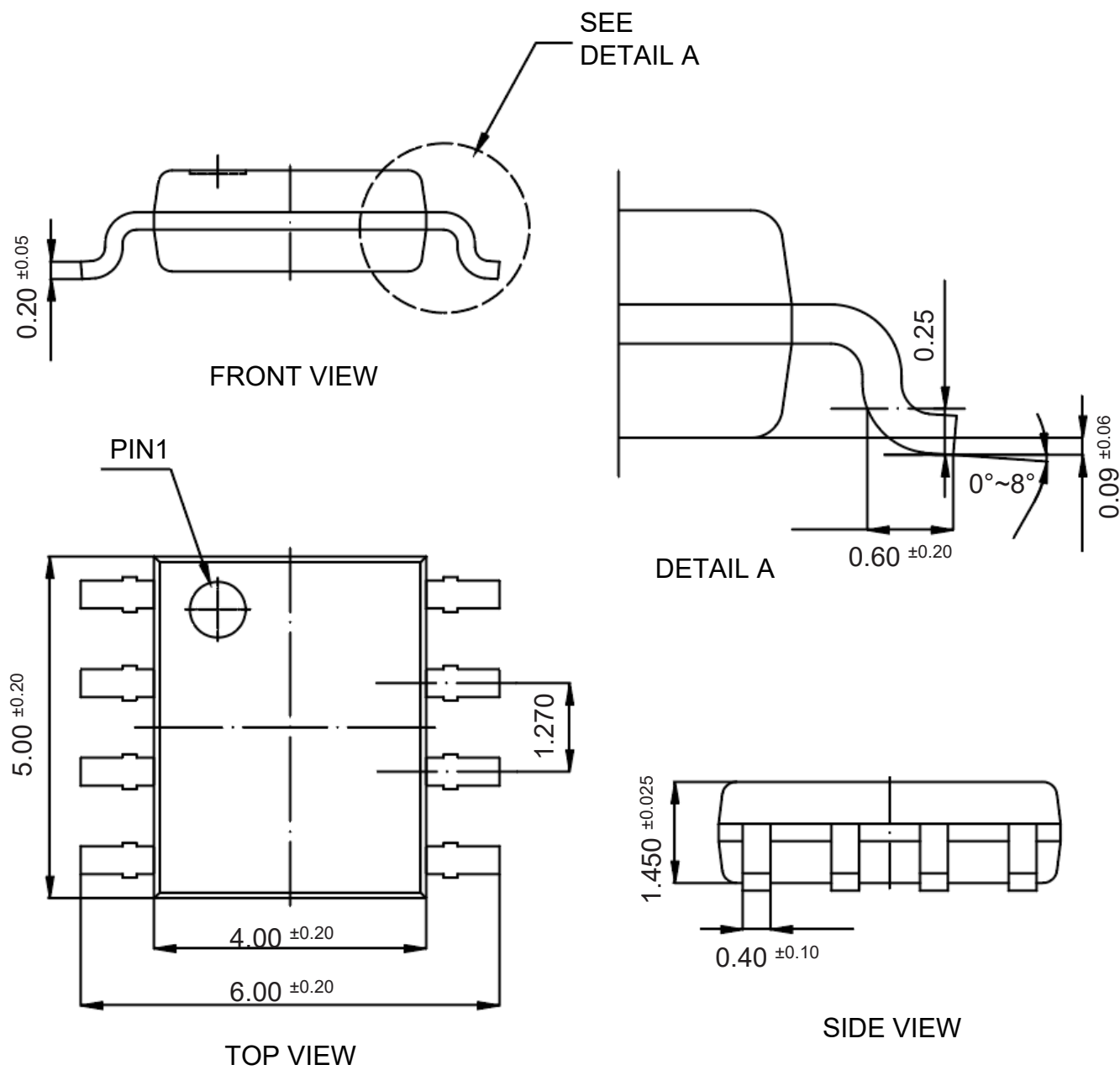


Figure 12: Peak Current Capacity



Package Outline

SOP-8
Dimensions in mm

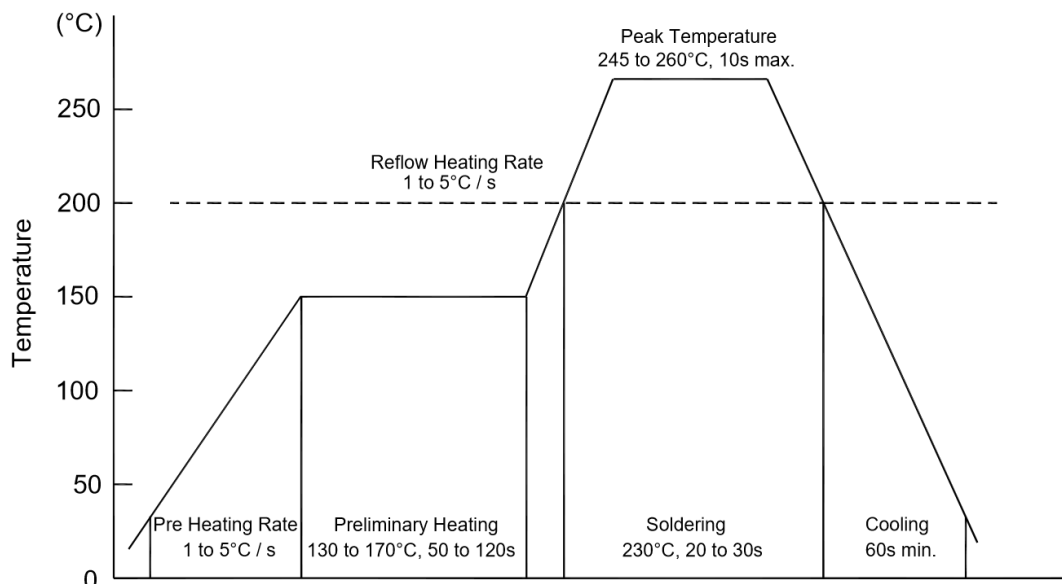


Ordering Information

Device	Package	Shipping
TN05P30JPA	SOP-8	4,000PCS/Reel&13inches

Conditions of Soldering and Storage

◆ Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters:

- Time length of peak temperature (longer)
- Time length of soldering (longer)
- Thickness of solder paste (thicker)

◆ Conditions of hand soldering

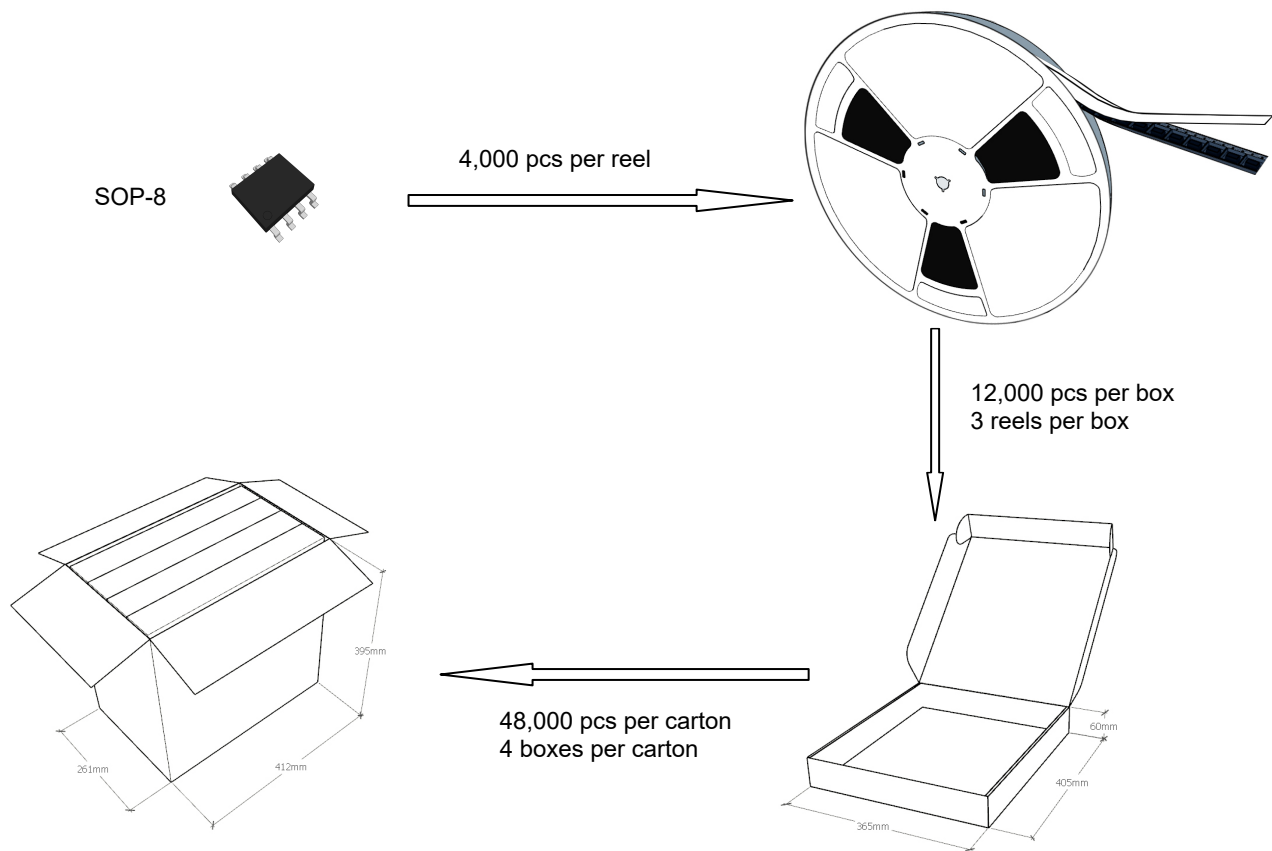
- Temperature: 370 °C
- Time: 3s max.
- Times: one time

◆ Storage conditions

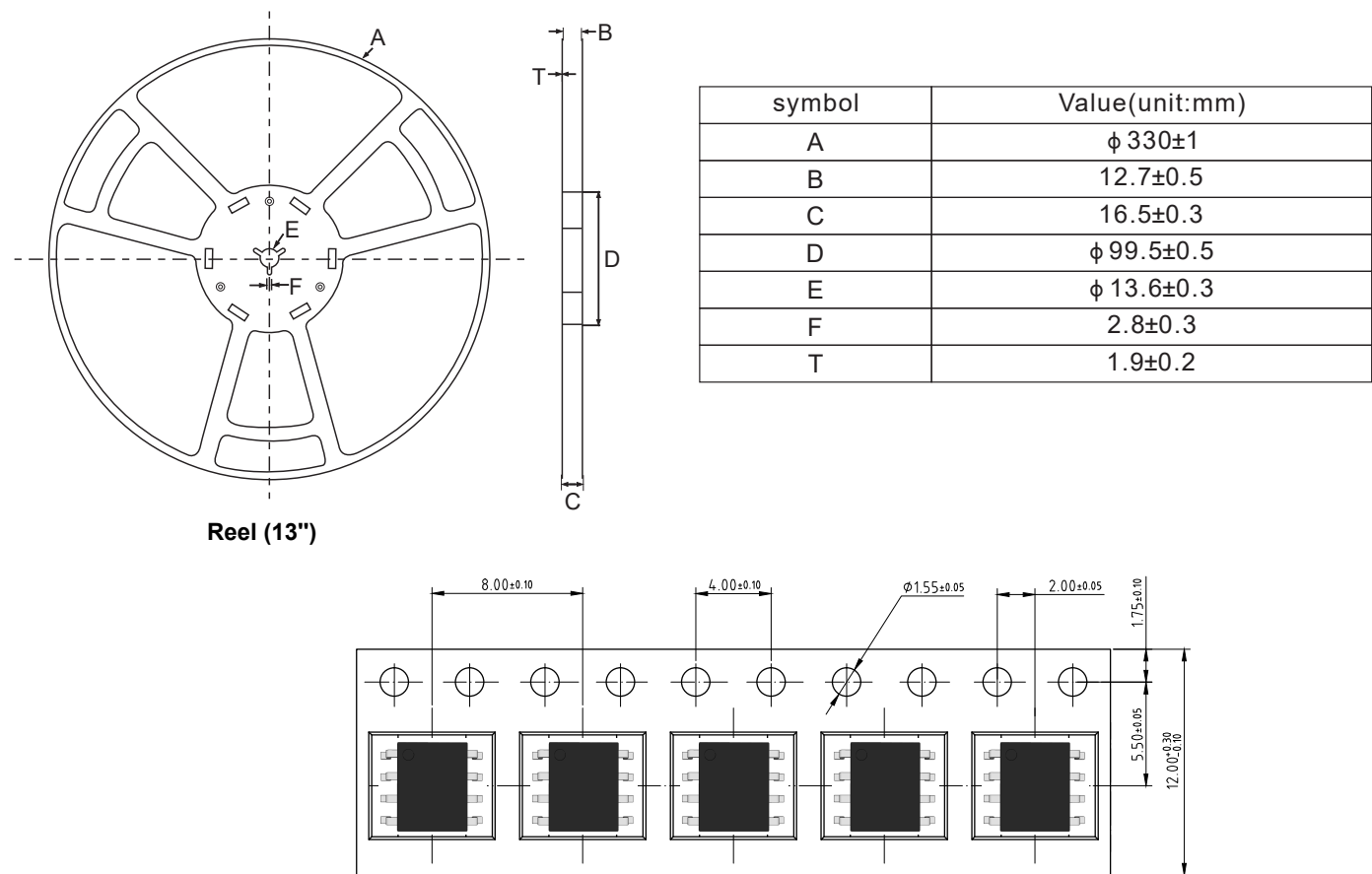
- **Temperature**
5 to 40 °C
- **Humidity**
30 to 80% RH
- **Recommended period**
One year after manufacturing

Package Specifications

- The method of packaging



◆ Embossed tape and reel data



Contact Information

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For additional information, please contact your local Sales Representative.



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The product specification aims to provide users with a reference regarding various product parameters, performance, and usage. It presents certain aspects of the product's performance in graphical form and is intended solely for users to select product and make product comparisons, enabling users to better understand and evaluate the characteristics and advantages of the product. It does not constitute any commitment, warranty, or guarantee.

The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. TANI shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and TANI assumes no responsibility for the application of the product. TANI strives to provide accurate and up-to-date information to the best of our ability. However, due to technical, human, or other reasons, TANI cannot guarantee that the information provided in the product specification is entirely accurate and error-free. TANI shall not be held responsible for any losses or damages resulting from the use or reliance on any information in these product specifications.

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